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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of: Paul A. Farrar et al.

THERMAL PROCESSING OF METAL ALLOYS FOR AN IMPROVED CMP PROCESS IN
INTEGRATED CIRCUIT FABRICATION

Attorney Docket No.: 303.469US3

JC986 U.S. PTO
09/945536
08/30/01**PATENT APPLICATION TRANSMITTAL****BOX PATENT APPLICATION**Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

- Return postcard.
- DIVISIONAL of prior Patent Application No. 09/038,252 (under 37 CFR § 1.53(b)) comprising:
- Specification (14 pgs, including claims numbered 1 through 19 and a 1 page Abstract).
 - Formal Drawing(s) (3 sheets).
 - Copy of signed Declaration (6 pgs) from prior application.
 - Copy of Power of Attorney from prior application (1 pg.).
 - Incorporation by Reference: *The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.*
- Prior application is assigned of record to Micron Technology, Inc..
- Information Disclosure Statement (1 pgs), Form 1449 (1 pgs). References NOT enclosed, cited in prior application.
- Preliminary Amendment (6 pgs).

The filing fee (NOT ENCLOSED) will be calculated as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	27 - 20 =	7	x 18 =	\$126.00
INDEPENDENT CLAIMS	8 - 3 =	5	x 80 =	\$400.00
[] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$710.00
				\$1,236.00

THE FILING FEE WILL BE PAID UPON RECEIPT OF THE NOTICE TO FILE MISSING PARTS.SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
P.O. Box 2938, Minneapolis, MN 55402 (612-373-6900)**Customer Number 21186**By: Edward J. Brooks
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This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to The Commissioner for Patents, Box Patent Application, Washington, D.C. 20231.